PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Dong-Hyun YEO	12/07/2011
Yong-Bum KIM	12/07/2011
Byung-Kil JEON	12/07/2011
Bong-Ju JUN	12/07/2011

RECEIVING PARTY DATA

Name:	Samsung Electronics Co., Ltd.	
Street Address:	416, Maetan-dong, Yeongtong-gu,	
City:	Suwon-si, Gyeonggi-do	
State/Country:	REPUBLIC OF KOREA	

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13323079

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	8071-471 (OPP20111069US)
NAME OF SUBMITTER:	FRANK CHAU

Total Attachments: 2

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OP \$40.00 1332

PATENT REEL: 027364 FRAME: 0473

ASSIGNMENT

AS A BELOW NAMED INVENTOR, I, and each of us, individually hereby declare that: IN CONSIDERATION of the sum of TEN (\$10.00) dollars or the equivalent thereof, and other good and valuable consideration, the receipt of which from the hereinafter named Assignee is hereby acknowledged, I do hereby sell, assign and forever grant and convey unto:

ASSIGNEE: Samsung Electronics Co., Ltd.

ADDRESS: 416, Maetan-dong, Yeongtong-gu, Suwon-si, Gyeonggi-do, KOREA

Who is my Assignee, and to the successes and assigns of my Assignee, all my right, title and interest, in and for the United States of America and all other countries, including all rights of priority, in and to the invention entitled:

TITLE: SEMICONDUCTOR DEVICE

<i>below)</i> and described either attached hereto	one inventor is named below) or us (if more than one inventor in an application for a United States patent the specificate or otherwise accompanies this Assignment or indicate , or is more particularly identified as:	ion of which is
executed on even da	ate herewith, or	
☐ Serial No	filed in the U.S. Patent & Trademark Office on	, or
□ executed on		•
to all certificates of cor examined patents, and patent when granted, t my Assignee, its succe terms, or any extension	I States patents which may be granted thereon and thereforections, divisions, continuations, continuations-in-part, reto any extensions thereof, said interest being the entire of to be held and enjoyed by said SAMSUNG ELECTRONIC essors, assigns or other legal representatives, to the full entering or renewal thereof, for which said patent or patents may esame would have been held and enjoyed by me or us if the ad not been made;	eissued and re- wnership of the CS CO., LTD., nd of the term, be granted, as
	covenant and agree to sign and execute any further from time-to-time be either necessary, lawful, proper or re	

AND I hereby covenant and agree to sign and execute any further documents or instruments which may from time-to-time be either necessary, lawful, proper or requested by the Assignee, in the prosecution of the above-named application or in the preparation and prosecution of any certificate of correction, division, continuation, continuation-in-part, reissue, re-examination, in any amendment, extension, or interference proceeding, whether administrative or judicial, or otherwise, to secure the title hereto in said Assignee;

AND I do hereby authorize and request the Commissioner of Patents and Trademarks to issue said Patent or Patents to the Assignee, and I hereby appoint as my, or our attorney, and authorize and request <u>Frank Chau, Reg. No. 34,136</u>, to insert on this Assignment any further identification or to complete such identification which may be either necessary or desirable in order to comply with the rules of the United States Patent and Trademark Office for recordation of this document.

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IN WITNESS WHEREOF, I and we have set our hands and seals on the dates written beside my and our respective names:

	INVENTOR(S)	Date Signed
(1)	Dong Hyun YEO, YEO, Dong-Hyun	December 7, 2011
(2)	Yong Bum Kim KIM, Yong-Bum	December 7, 2011
(3)	JEON, Byung Kil	December 7, 2011
(4)	JUN, Borg-Ju	December 7, 2011